

# ACS03MS

# Radiation Hardened Quad 2-Input NAND Gate with Open Drain

January 1996

#### Features

- Devices QML Qualified in Accordance with MIL-PRF-38535
- Detailed Electrical and Screening Requirements are Contained in SMD# 5962-96703 and Intersil's QM Plan
- 1.25 Micron Radiation Hardened SOS CMOS
- Total Dose ......>300K RAD (Si)
- Single Event Upset (SEU) Immunity: <1 x 10<sup>-10</sup> Errors/Bit/Day (Typ)
- SEU LET Threshold . . . . . . . . . . . >100 MEV-cm<sup>2</sup>/mg
- Dose Rate Upset ......>10<sup>11</sup> RAD (Si)/s, 20ns Pulse
- Dose Rate Survivability . . . . . . . > 10<sup>12</sup> RAD (Si)/s, 20ns Pulse
- Latch-Up Free Under Any Conditions
- Significant Power Reduction Compared to ALSTTL Logic
- DC Operating Voltage Range ...... 4.5V to 5.5V
- Input Logic Levels
  - VIL = 30% of VCC Max
  - VIH = 70% of VCC Min
- Input Current ≤ 1μA at VOL, VOH
- Fast Propagation Delay . . . . . . . . . . . . . . . . . 15ns (Max), 10ns (Typ)

#### Description

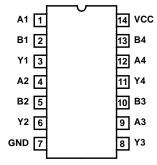
The Intersil ACS03MS is a Radiation Hardened quad 2-input NAND gate with open drain outputs. The open drain output can drive resistive loads from a separate supply voltage.

The ACS03MS utilizes advanced CMOS/SOS technology to achieve high-speed operation. This device is a member of a radiation hardened, high-speed, CMOS/SOS Logic Family.

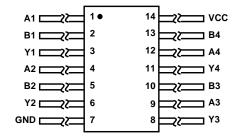
The ACS03MS is supplied in a 14 lead Ceramic Flatpack (K suffix) or a Ceramic Dual-In-Line Package (D suffix).

#### **Pinouts**

14 PIN CERAMIC DUAL-IN-LINE MIL-STD-1835 DESIGNATOR CDIP2-T14, LEAD FINISH C TOP VIEW



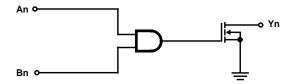
14 PIN CERAMIC FLATPACK
MIL-STD-1835 DESIGNATOR CDFP3-F14,
LEAD FINISH C
TOP VIEW



### **Ordering Information**

PART NUMBER	TEMPERATURE RANGE	SCREENING LEVEL	PACKAGE
5962F9670301VCC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead SBDIP
5962F9670301VXC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead Ceramic Flatpack
ACS03D/Sample	25°C	Sample	14 Lead SBDIP
ACS03K/Sample	25°C	Sample	14 Lead Ceramic Flatpack
ACS03HMSR	25°C	Die	Die

# Functional Diagram



#### TRUTH TABLE

INPUTS		ОИТРИТ	
An	Bn	Yn	
L	L	Z (Note 2), H (Note 3)	
L	Н	Z (Note 2), H (Note 3)	
Н	L	Z (Note 2), H (Note 3)	
Н	Н	L	

#### NOTES:

- 1. L = Low, H = High, Z = High Impedance
- 2. Without Pull-up Resistor
- 3. With Pull-up Resistor

#### ACS03MS

## Die Characteristics

#### **DIE DIMENSIONS:**

68 mils x 79 mils 1730mm x 2010mm

## METALLIZATION:

Type: AlSi

Metal 1 Thickness: 7.125kÅ ±1.125kÅ Metal 2 Thickness: 9kÅ ±1kÅ

#### **GLASSIVATION:**

Type: SiO<sub>2</sub>

Thickness: 8kÅ ±1kÅ

#### **WORST CASE CURRENT DENSITY:**

 $< 2.0 \times 10^5 \text{A/cm}^2$ 

#### **BOND PAD SIZE:**

 $110\mu m~x~110\mu m$  4.3 mils x 4.3 mils

## Metallization Mask Layout

# ACS03MS vcc В1 Α1 В4 (13) (1) (14) (2) Y1 (3) (12) A4 (11) Y4 A2 (4) B2 (5) (10) B3 Y2 (6) (9) A3 (7) (8) GND

## ACS03MS

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